



**ES3A---ES3J**

**SUPER FAST RECOVERY RECTIFIERS**

**REVERSE VOLTAGE: 50 --- 600 V CURRENT: 3.0 A**

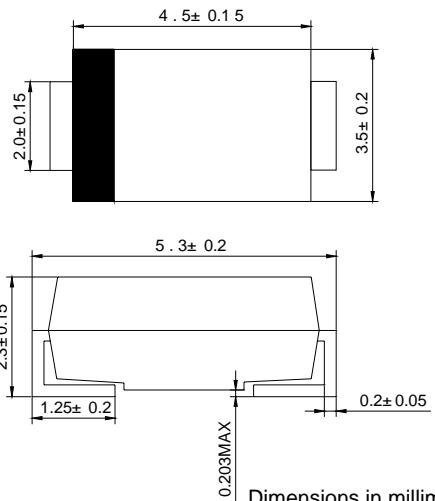
## FEATURES

- ◇ Low cost
- ◇ Low leakage
- ◇ Low forward voltage drop
- ◇ High current capability
- ◇ Easily cleaned with Alcohol, Isopropanol and similar solvents
- ◇ The plastic material carries U/L recognition 94V-0

## MECHANICAL DATA

- ◇ Case: JEDEC DO-214AA, molded plastic
- ◇ Terminals: Solderable per MIL-STD-202, Method 208
- ◇ Polarity: Color band denotes cathode
- ◇ Weight: 0.003 ounces, 0.093 gram
- ◇ Mounting position: Any

## DO-214AA(SMB)



Dimensions in millimeters

## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate by 20%.

		ES3A	ES3B	ES3C	ES3D	ES3G	ES3H	ES3J	UNITS
Maximum recurrent peak reverse voltage	V <sub>RRM</sub>	50	100	150	200	400	500	600	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	280	350	420	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	150	200	400	500	600	V
Maximum average forward rectified current @T <sub>A</sub> =100°C	I <sub>F(AV)</sub>					3.0			A
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load @T <sub>J</sub> =125°C	I <sub>FSM</sub>					100			A
Maximum instantaneous forward voltage at 3.0 A	V <sub>F</sub>		0.98		1.35	1.70			V
Maximum reverse current @T <sub>A</sub> =25°C at rated DC blocking voltage @T <sub>A</sub> =125°C	I <sub>R</sub>			5.0		500			μ A
Typical reverse recovery time (Note1)	t <sub>rr</sub>			35					ns
Typical junction capacitance (Note2)	C <sub>J</sub>			45					pF
Typical thermal resistance	R <sub>θJA</sub>			40					°C/W
Operating junction temperature range	T <sub>J</sub>		- 55 ---- + 150						°C
Storage temperature range	T <sub>STG</sub>		- 55 ---- + 150						°C

NOTE: 1. Measured with I<sub>F</sub>=0.5A, I<sub>R</sub>=1A, I<sub>rr</sub>=0.25A

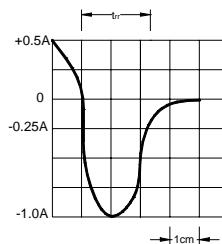
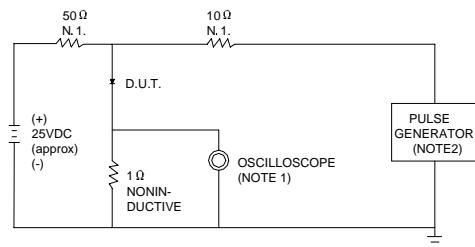
2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Thermal resistance from junction to ambient and junction to lead P.C.B. mounted on 0.27"X0.27"(7.0X7.0mm<sup>2</sup>) copper pad areas

# RATINGS AND CHARACTERISTIC CURVES

**ES3A-- ES3J**

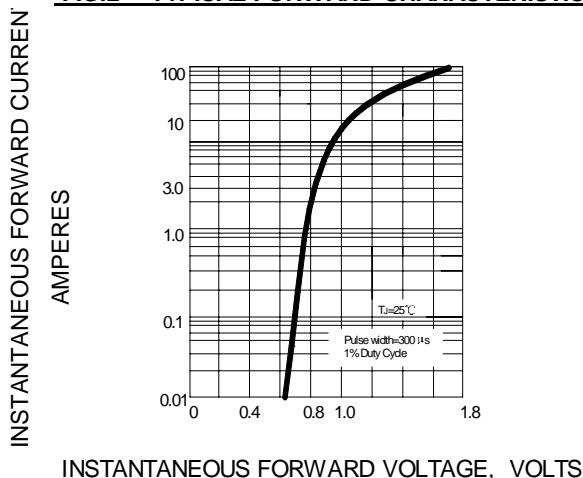
**FIG.1 -- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC**



NOTES:  
1.RISE TIME = 7ns MAX.INPUT IMPEDANCE = 1MΩ .22pF.  
2.RISE TIME =10ns MAX.SOURCE IMPEDANCE=50 Ω.

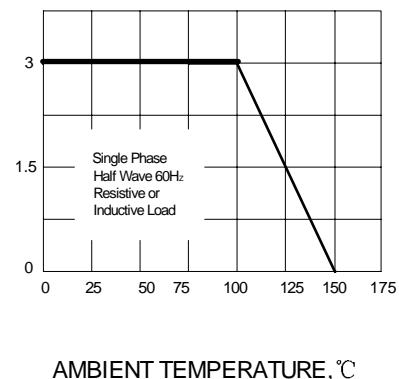
SET TIME BASE FOR 20/30 ns/cm

**FIG.2 -- TYPICAL FORWARD CHARACTERISTIC**



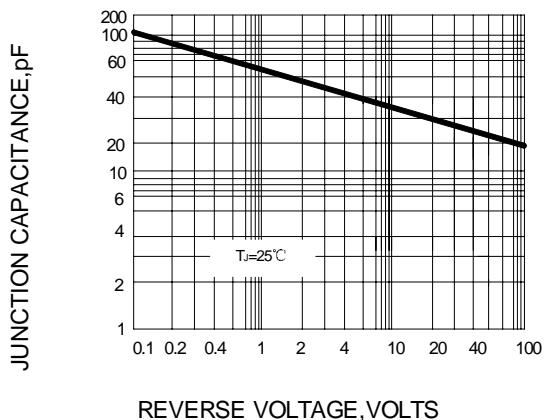
INSTANTANEOUS FORWARD CURRENT  
AMPERES

**FIG.3 -- FORWARD DERATING CURVE**



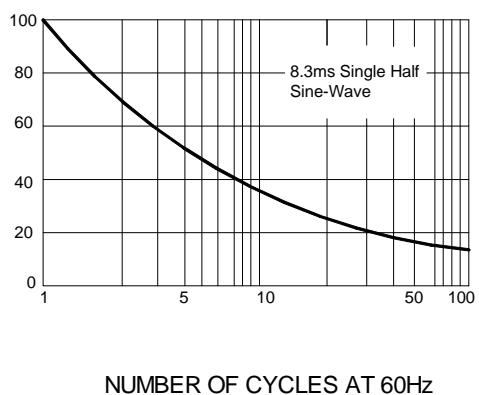
AMBIENT TEMPERATURE, °C

**FIG.4 -- TYPICAL JUNCTION CAPACITANCE**



JUNCTION CAPACITANCE,pF  
REVERSE VOLTAGE, VOLTS

**FIG.5 -- PEAK FORWARD SURGE CURRENT**



NUMBER OF CYCLES AT 60Hz